

INTERNATIONAL STANDARD

NORME INTERNATIONALE

**Field Device Integration (FDI) –
Part 101-2: Profiles – Foundation Fieldbus HSE**

**Intégration des appareils de terrain (FDI) –
Partie 101-2: Profils – Foundation Fieldbus HSE**

Withdrawing





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FIELD DEVICE INTEGRATION (FDI) –

Part 101-2: Profiles – Foundation Fieldbus HSE

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The text of this standard is based on the following documents:

CDV	Report on voting
65E/353/CDV	65E/416/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

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